SPECIFICATION
产品规格书

REFOND P/N 产品型号

RF-K*HP32DS-FG-2J

☐R&D 研发

■Mass Product 量产供货

电话：0755-2967-5000
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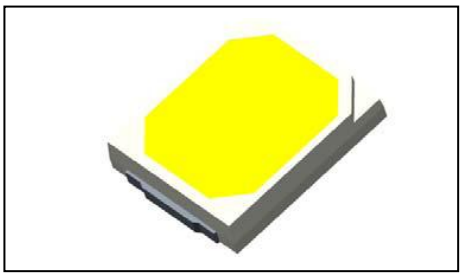
Contents 目录

1. Description 产品介绍 3
1.1General Description 产品描述 3
1.2Features 产品特征 3
1.3Application 产品应用 3
1.4Package Dimension 封装尺寸 4
1.5Product Parameters 产品参数 5
1.6 Bin Range Of Forward Voltage and Luminous Flux 电压与流明分 BIN 范围 7
1.7Electro-Optical Characteristics 光电特性 7
1.8 Typical optical characteristics curves 典型光学特性曲线 9
2. Packaging 产品包装 13
2.1 Packaging Specification 包装规格 13
2.1.1Carrier Tape Dimension 载带尺寸 13
2.1.2Reel Dimension 卷盘尺寸 13
2.1.3Label Form Specification 标签规格 14
2.2Moisture Resistant Packing 防潮包装 14
2.3Cardboard Box 包装纸箱 14
2.4 Reliability Test Items And Conditions 信赖性测试项目及条件 15
2.5 Criteria For Judging Damage 失效判定标准 16
3. SMT Reflow Soldering Instructions SMT 回流焊说明 17
3.1SMT Reflow Soldering Instructions SMT 回流焊说明 17
4. Handling Precautions 产品使用注意事项 19
4.1 Handling Precautions 产品使用注意事项 19

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1. Description 产品介绍

1.1General Description 产品描述



The White LED which was fabricated using a blue chip and the phosphor, Product Package:2.75mmX3.5mmX0.7mm.

该产品为白光 LED，是由蓝光芯片激发荧光粉而形成，产品尺寸：2.75mmX3.5mmX0.7mm。

1.2Features 产品特征

►PLCC-2Package.PLCC-2封装

►Extremely wide viewing angle.发光角度大

►Suitable for all SMT assembly and solder process.适用于所有的SMT组装和焊接工艺

►Available on tape and reel.适用于载带及卷轴

►Moisture sensitivity level: Level 3.防潮等级 Level 3

►RoHS compliant.满足RoHS要求

►PCT Leadframe.PCT支架

1.3Application 产品应用

►Indoor lighting.室内照明

►Panel light.面板灯

►General indoor applications.其它适合的室内应用

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1.4Package Dimension 封装尺寸

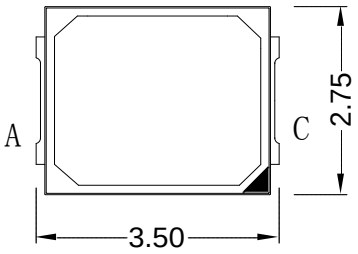


Fig.1-1 Top view 正面视图

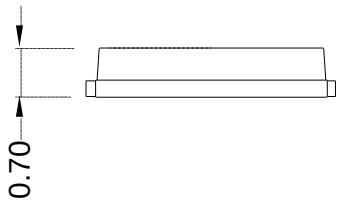


Fig.1-2 Side view 侧面视图

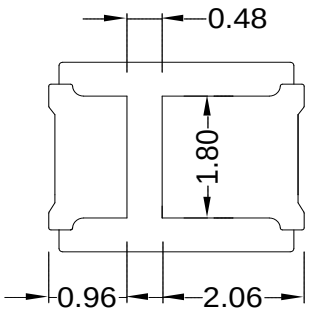


Fig.1-3 Bottom view 背面视图

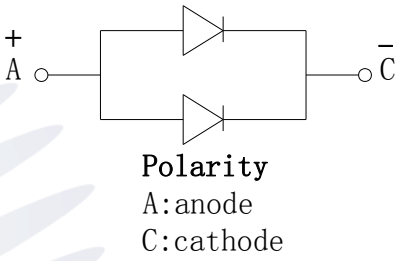


Fig.1-4 Polarity 极性

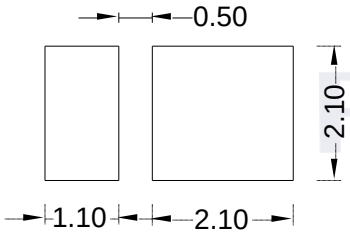


Fig.1-5 Soldering patterns 推荐焊盘

Notes 备注:

1. All dimensions units are millimeters. 所有尺寸标注单位为毫米
2. All dimensions tolerances are ±0.05mm unless otherwise noted.除特别标注外，所有尺寸公差为±0.05 毫米

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1.5Product Parameters 产品参数

Table 1-1 Electrical / Optical Characteristics at Ts=25°C 电性与光学特性

Item 项目	Code 代码	Symbol 符号	Test Condition 测试条件	Value			Unit 单位
				Min. 最小值	Typ. 典型值	Max. 最大值	
Forward Voltage 正向电压	Rank G1	V_F	I_F=150mA	2.8	2.9	2.9	V
	Rank G2			2.9		3.0	V
RF-K2HP32DS-FG-2J ERP2700K	Rank THA	Φ_v	I_F=150mA	75	83	80	lm
	Rank UEA			80		85	lm
RF-K3HP32DS-FG-2J ERP3000K	Rank THA	Φ_v	I_F=150mA	75	85	80	lm
	Rank UEA			80		85	lm
	Rank UFA			85		90	lm
RF-K35HP32DS-FG-2J ERP3500K	Rank UEA	Φ_v	I_F=150mA	80	86	85	lm
	Rank UFA			85		90	lm
RF-K4HP32DS-FG-2J ERP4000K	Rank UEA	Φ_v	I_F=150mA	80	88	85	lm
	Rank UFA			85		90	lm
	Rank UGA			90		95	lm
RF-K5HP32DS-FG-2J ERP5000K	Rank UEA	Φ_v	I_F=150mA	80	88	85	lm
	Rank UFA			85		90	lm
	Rank UGA			90		95	lm
RF-K6HP32DS-FG-2J ERP6500K	Rank UEA	Φ_v	I_F=150mA	80	86	85	lm
	Rank UFA			85		90	lm
Reverse Current (漏电流)		I_R	V_R=5V	---	---	10	uA
Viewing Angle (发光角度)		2θ1/2	I_F=150mA	---	120	---	deg
Color Rendering Index (显色指数)		Ra		80	---	---	---
		R9		0	---	---	---
Thermal Resistance (热阻)		R_{THJ-S}	I_F=150mA	---	10	---	℃/W

Table 1-2 Absolute Maximum Ratings at Ts=25°C 绝对最大值

Parameter（参数）	Symbol（符号）	Rating（值）	Units（单位）
Power Dissipation（功耗）	P_D	930	mW
Forward Current（正向电流）	I_F	300	mA

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Peak Forward Current （峰值电流）	I_{FP}	360	mA
Reverse Voltage（反向电压）	V_R	5	V
Electrostatic Discharge(HBM)（静电）	ESD	2000	V
Operating Temperature（操作温度）	T_{OPR}	-40 ~+100	℃
Storage Temperature（储存温度）	T_{STG}	-40 ~ +100	℃
Junction Temperature（结温）	T_J	125	℃

Notes 备注：

1. Pulse width≤0.1ms, duty cycle≤1/10. 脉宽≤0.1ms,占空比≤1/10.

2. The above forward voltage measurement allowance tolerance is ±0.1V. 以上所示电压测量误差 ±0.1V.

3. The above color coordinates measurement allowance tolerance is±0.005. 以上所示坐标测量误差±0.005.

4. The above luminous intensity measurement allowance tolerance ±10%. 上述发光强度的测试允许公差为±10%.

5. The above color rendering index measurement allowance tolerance is Ra±2, R9±3.以上显色性指数的测试允许公差为Ra±2, R9±3.

6. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product. 使用功率不能超过规定的最大值。

7. All measurements were made under the standardized environment of Refond. 所有测试都是基于瑞丰现有的标准测试平台。

8.When the LEDs are in operation the maximum current should be decided after measuring the package temperature，junction temperature should not exceed the maximum rate. LED使用的最大电流需要根据散热条件确定，结温不能超过最大值。

9. ESD yield is over 90% at 2000V ESD (HBM). ESD protection during products handing is needed. 90%的LED通过人体模式ESD2000V 测试，在操作时请注意静电防护。

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1.6 Bin Range Of Forward Voltage and Luminous Flux 电压与流明分 BIN 范围

Table 1-3

VF(V)	电流IF	G1	G2	/	/
	150mA	2.8-2.9	2.9-3.0	/	/
Φ (LM)	电流IF	THA	UEA	UFA	UGA
	150mA	75-80	80-85	85-90	90-95

1.7Electro-Optical Characteristics 光电特性

Table 1-4

VF(V)	150mA	2.8-2.9	2.9-3.0	/	/
	60mA	2.66-2.76	2.76-2.86	/	/
Φ (LM)	150mA	75-80	80-85	85-90	90-95
	60mA	31.7-33.8	33.8-35.9	35.9-38	38-40

Note:

LM &VF Values are for representative reference only.

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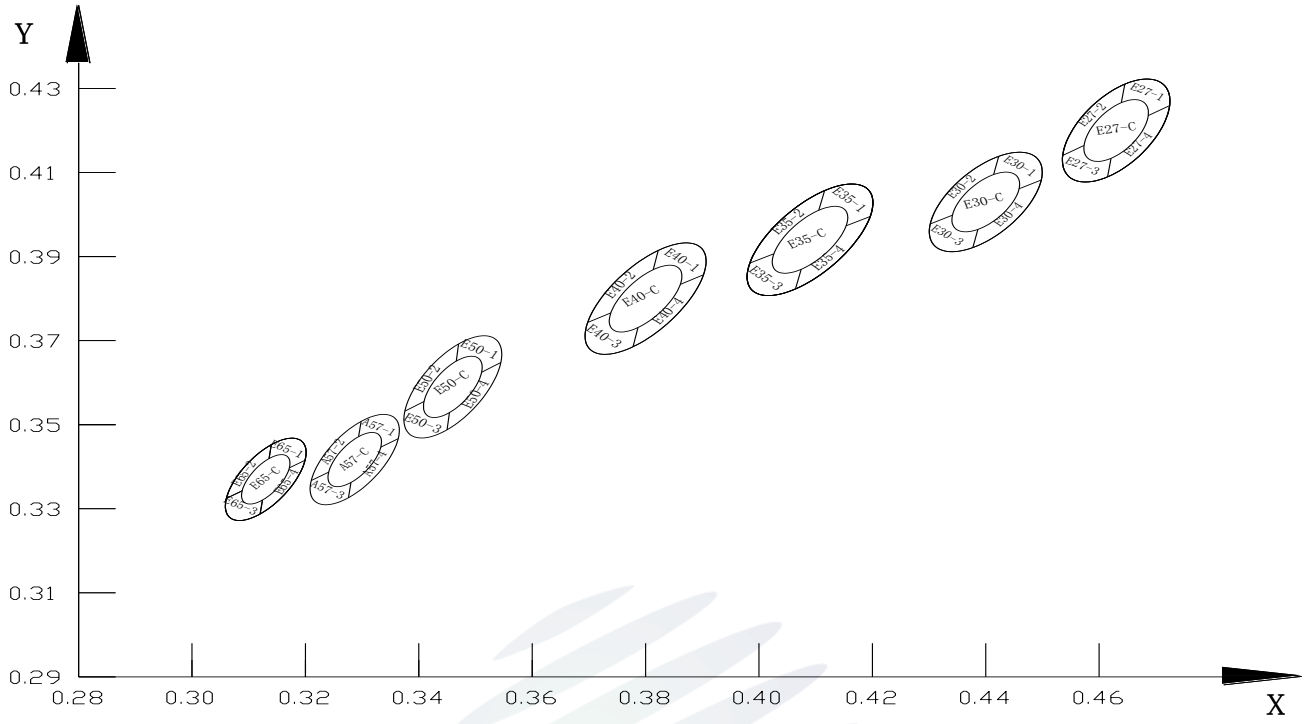


Fig 1-6 The C.I.E Chromaticity Diagram CIE色度

Table 1-4 Color Coordinates 色坐标

ERP						
BIN CODE	X	Y	a	b	θ	Tc(K)
E27-C(3Step)	0.4630	0.4200	0.00774	0.00411	57.28	2665-2790K
E27-1/2/3/4(5Step)			0.01290	0.00685		2625-2840K
E30-C(3Step)	0.4400	0.4030	0.00834	0.00408	53.17	2860-3020K
E30-1/2/3/4(5Step)			0.01390	0.00680		2810-3080K
E35-C(3Step)	0.4090	0.3940	0.00951	0.00417	53	3335-3555K
E35-1/2/3/4(5Step)			0.01585	0.00695		3270-3635K
E40-C(3Step)	0.3800	0.3800	0.00939	0.00402	54.00	3895-4180K
E40-1/2/3/4(5Step)			0.01565	0.00670		3810-4285K
E50-C(3Step)	0.3460	0.3590	0.00822	0.00354	59.62	4815-5165K
E50-1/2/3/4(5Step)			0.01370	0.00590		4710-5295K
E65-C(3Step)	0.3130	0.3370	0.00669	0.00285	58.38	6200-6690K
E65-1/2/3/4(5Step)			0.01115	0.00475		6085-6875K

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1.8 Typical optical characteristics curves 典型光学特性曲线

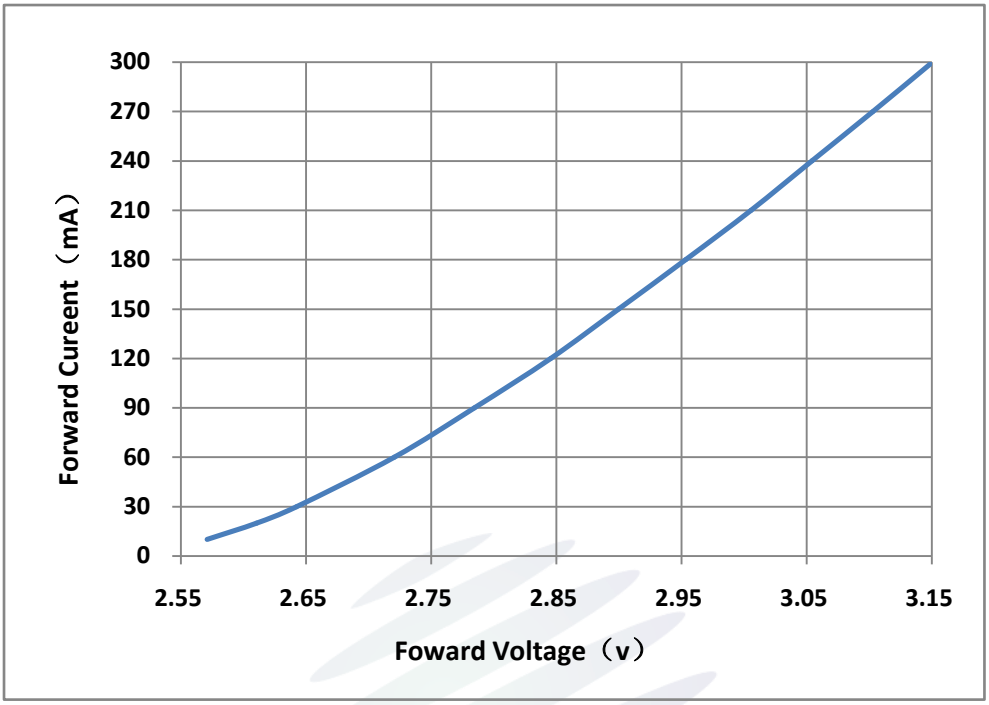


Fig 1-7Forward Voltage Vs. Forward Current伏安特性曲线

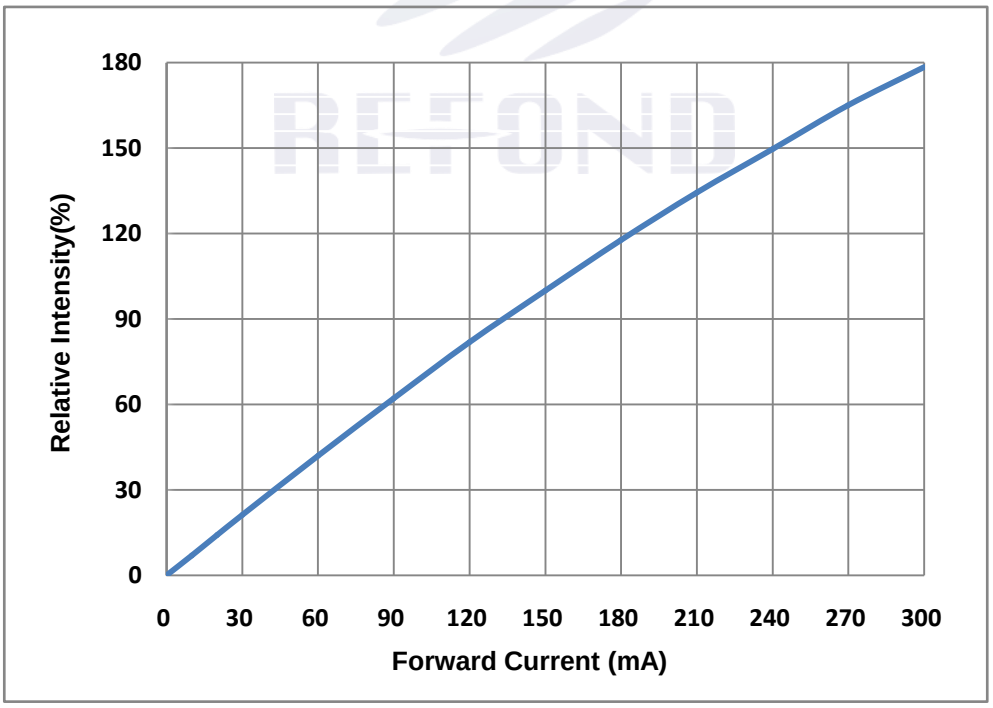


Fig 1-8Forward Current Vs. Relative Intensity正向电流与相对光强特性曲线

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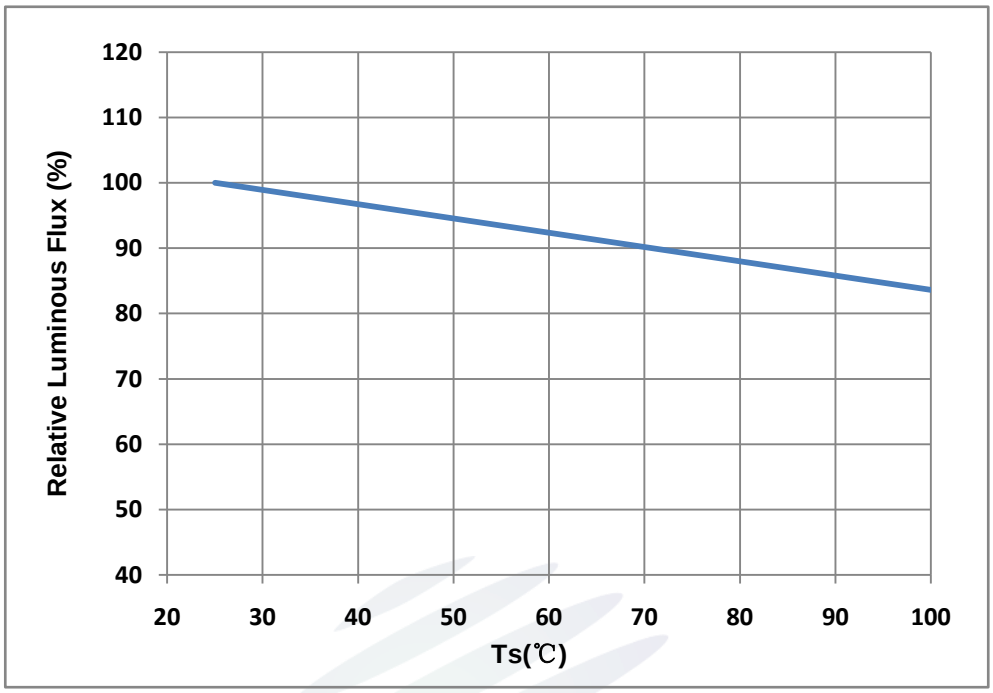


Fig 1-9Pin Temperature Vs Relative Intensity管脚温度与相对光强特性曲线

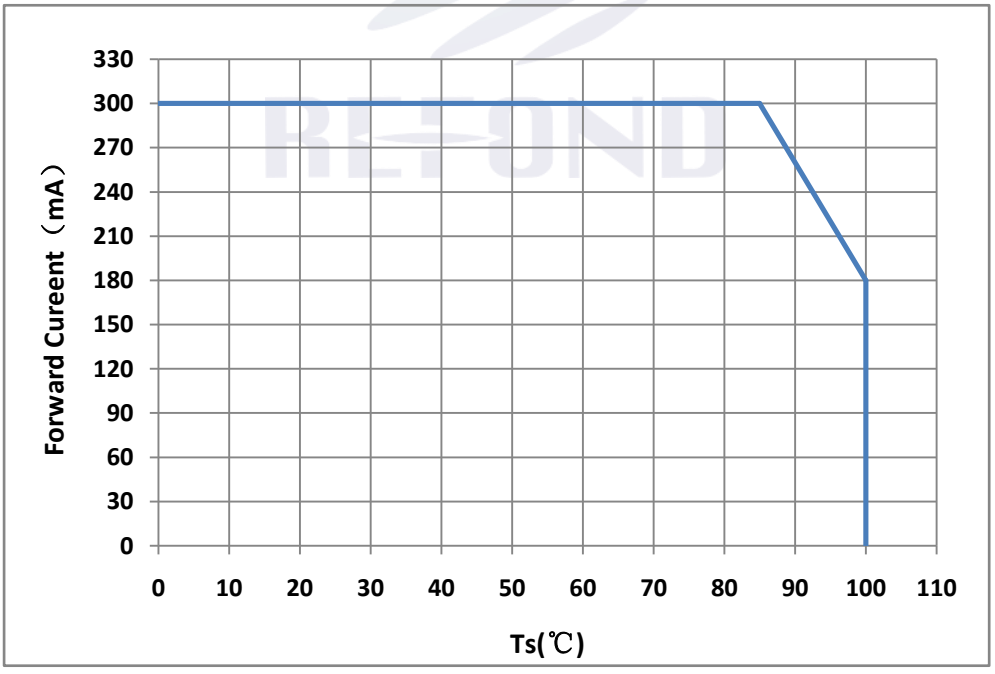


Fig 1-10Pin Temperature Vs.Forward Current管脚温度与正向电流特性曲线

Tj≤125℃

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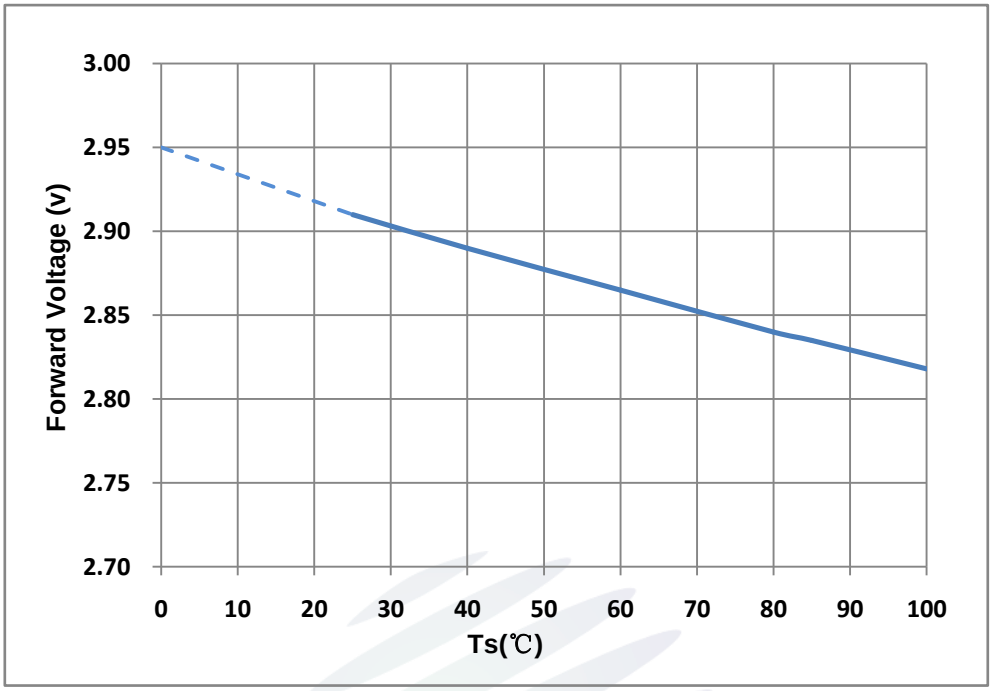


Fig 1-11Forward Voltage VsPin Temperature电压与管脚温度特性曲线

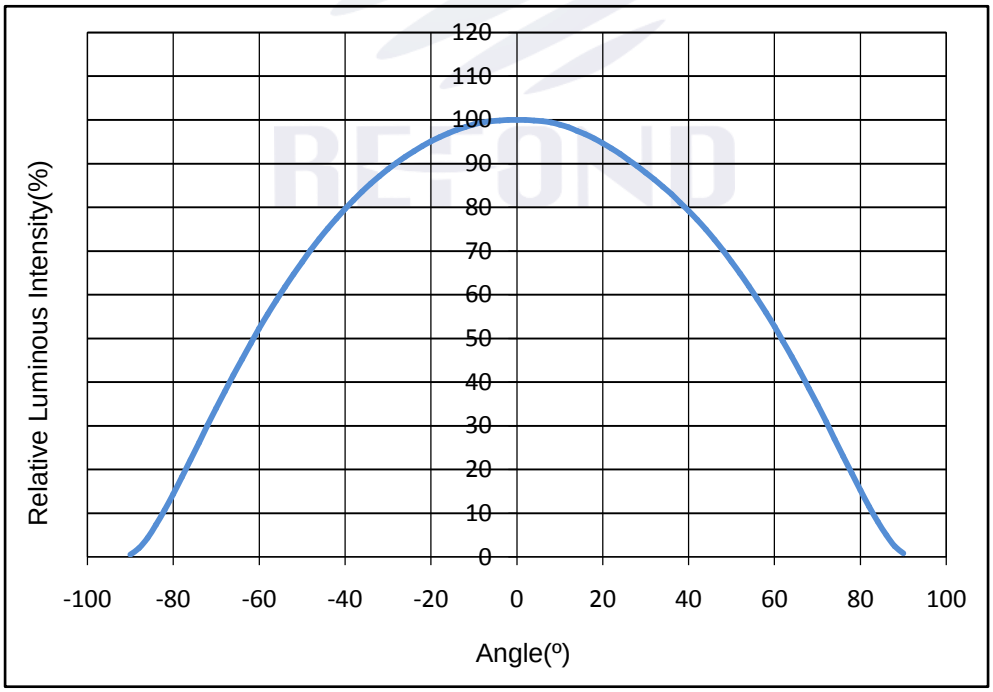


Fig 1-12Radiation diagram辐射特性曲线

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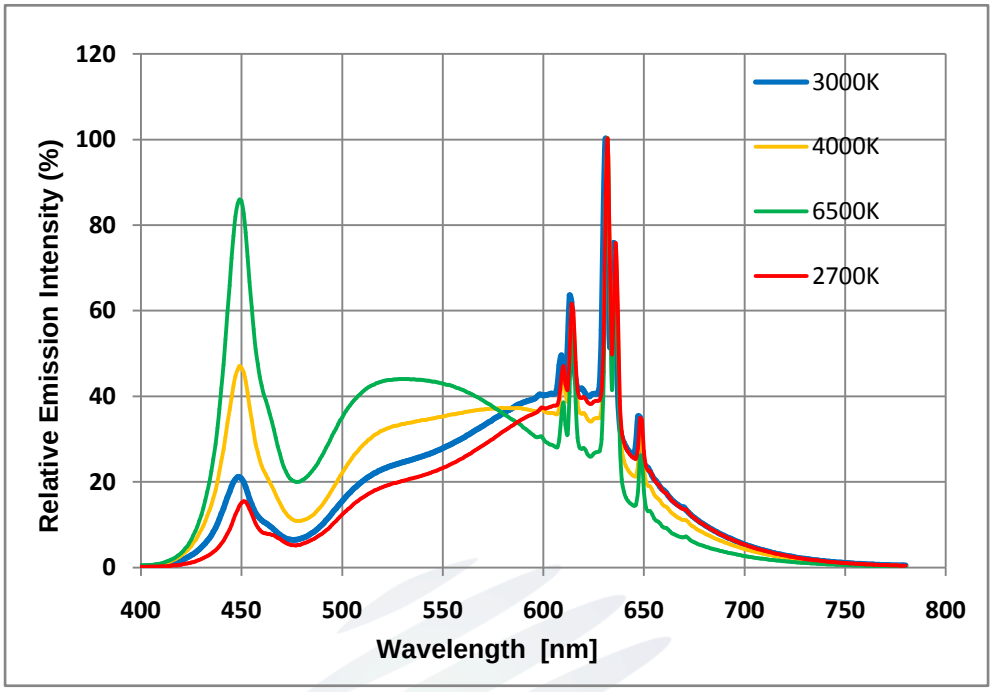


Fig 1-13Spectrum Distribution光谱分布特性曲线

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2. Packaging 产品包装

2.1 Packaging Specification 包装规格

Package:16000pcs/reel or 4000pcs/reel.包装每卷 16000pcs 或 4000pcs。

2.1.1Carrier Tape Dimension 载带尺寸

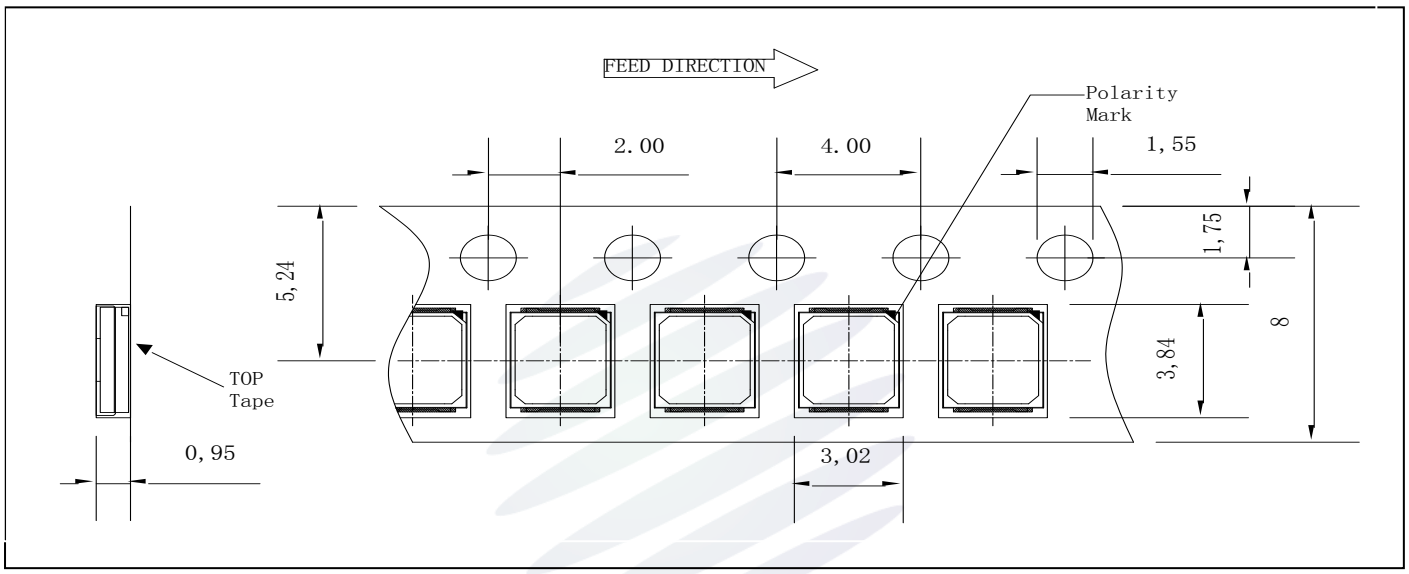


Fig.2-1 Carrier Tape Dimension 载带尺寸

2.1.2Reel Dimension 卷盘尺寸

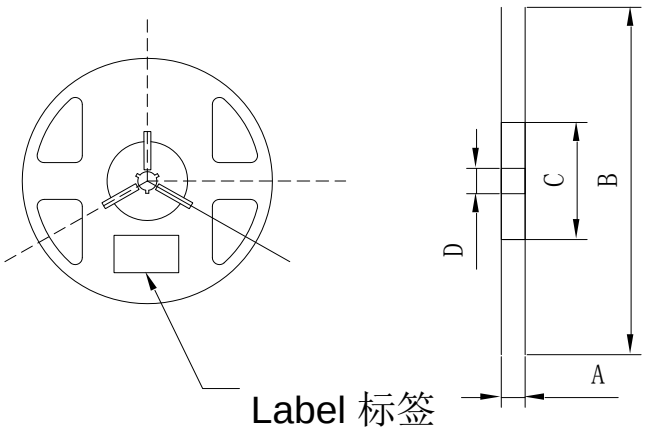


Fig.2-2Title

Table 2-1 Title

	16000pcs	4000pcs
A	12.7±0.3mm	11.75±0.3mm
B	330.2±2mm	177.8±0.2mm
C	79.5±0.2mm	58.5±0.2mm
D	14.3±0.2mm	13.5±0.2mm

Notes 备注:

The tolerances unless mentioned ±0.1mm. Unit : mm注：未注公差为±0.1毫米，尺寸单位：毫米。

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2.1.3Label Form Specification 标签规格

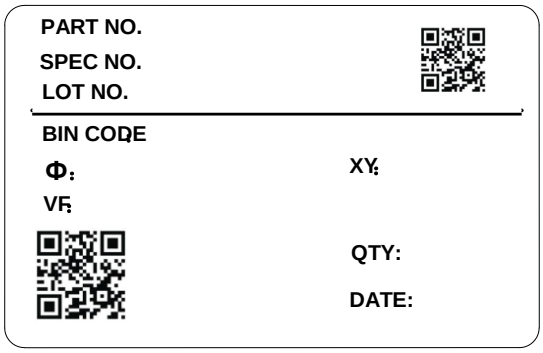


Fig 2-3 Title

Table 2-2 Title

PART NO.	Part Number 品名
SPEC NO.	Spec Number 规格
LOT NO.	Lot Number 批次号
BIN CODE	Bin Code 参数代码
Φ	Luminous flux 光通量
XY	Chromaticity Bin 色区
V_F	Forward Voltage 正向电压
QTY	Packing Quantity 数量
DATE	Made Date 生产日期

2.2Moisture Resistant Packing 防潮包装

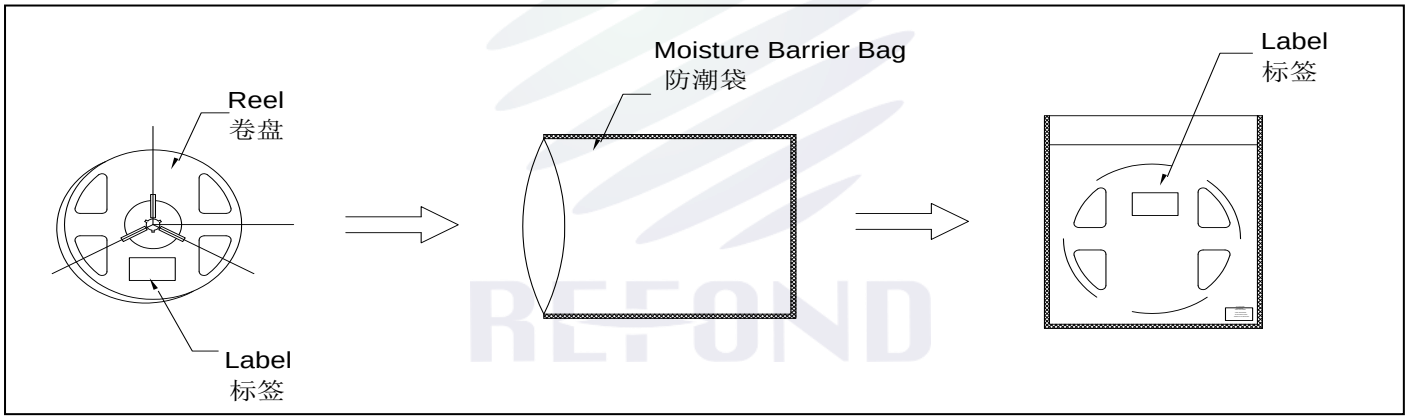


Fig.2-4Title

2.3Cardboard Box 包装纸箱

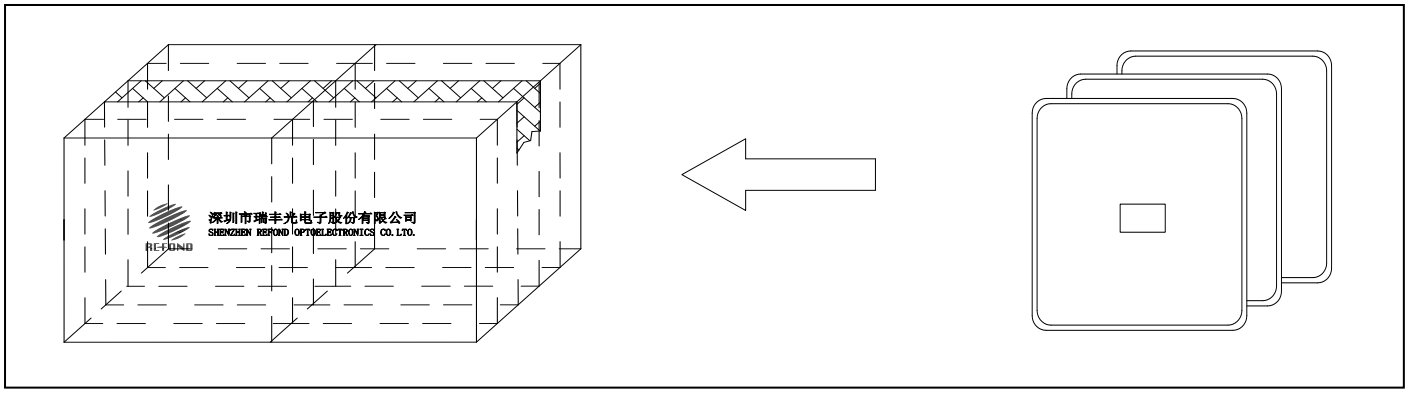


Fig.2-5Title

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2.4 Reliability Test Items And Conditions 信赖性测试项目及条件

Table 2-3 Title

TestItems 项目	Ref.Standard 参考标准	Test Condition 测试条件	Time 时间	Quantity 数量	Ac/Re 接收/拒收
Reflow 回流焊	JESD22-B106	Temp:260℃max T=10 sec	2times	10pcs	0/1
Thermal Shock 冷热冲击	JEITAED-4701 300307	-40℃ 15min ↑↓10s 100℃ 15min	200cycles	10pcs	0/1
High Temperature Storage 高温保存	JEITAED-4701 200 201	Temp:100℃	1000hrs	10pcs	0/1
Low Temperature Storage 低温保存	JEITA ED-4701 200 202	Temp:-40℃	1000hrs	10pcs	0/1
Life Test 常温通电	JESD22-A108	Ta=25℃ I_F=150mA	1000hrs	10pcs	0/1
High Temperature High Humidity Life Test 高温高湿通电	JESD22-A101	60℃/ 90%R_H I_F=150mA	1000hrs	10pcs	0/1
Temperature Humidity Storage 高温高湿储存	JEITA ED-4701 100 103	T_A=85℃ R_H=85%	1000hrs	10pcs	0/1

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2.5 Criteria For Judging Damage 失效判定标准

Table 2-4 Title

Test Items 项目	Symbol 符号	Test Condition 测试条件	Criteria For Judgement 判定标准	
			Min. 最小	Max. 最大
Forward Voltage 正向电压	V_F	I_F=150mA	-	(U.S.L*)x1.1
Reverse Current 反向电流	I_R	V_R = 5V	-	(U.S.L*)x2.0
Luminous Flux 光通量	Φ	I_F=150mA	(L.S.L*)x0.7	-

Notes 备注：

1.U.S.L: Upper standard level 规格上限 L.S.L: Lower standard level 规格下限

2. The above reliability tests are based on the verification of a single/strip LED of Refond's existing experimental platform,the reliability experimental was taken under good heat dissipation conditions.When customers applies the LED to the series and parallel circuit,should take consideration of all the factors such as the current,voltage distribution,heat dissipation and others. 以上可靠性测试是基于瑞丰现有实验平台单颗/条 LED 在良好散热条件验证下的结果。客户端将 LED 应用于串、并联线路时，需自行评估电流、电压分配、散热等问题。

3.The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license. 以上技术数据仅为产品的典型值，只作为参考，不作为任何应用条件及应用方式的保证。

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3. SMT Reflow Soldering Instructions SMT 回流焊说明

3.1SMT Reflow Soldering Instructions SMT 回流焊说明

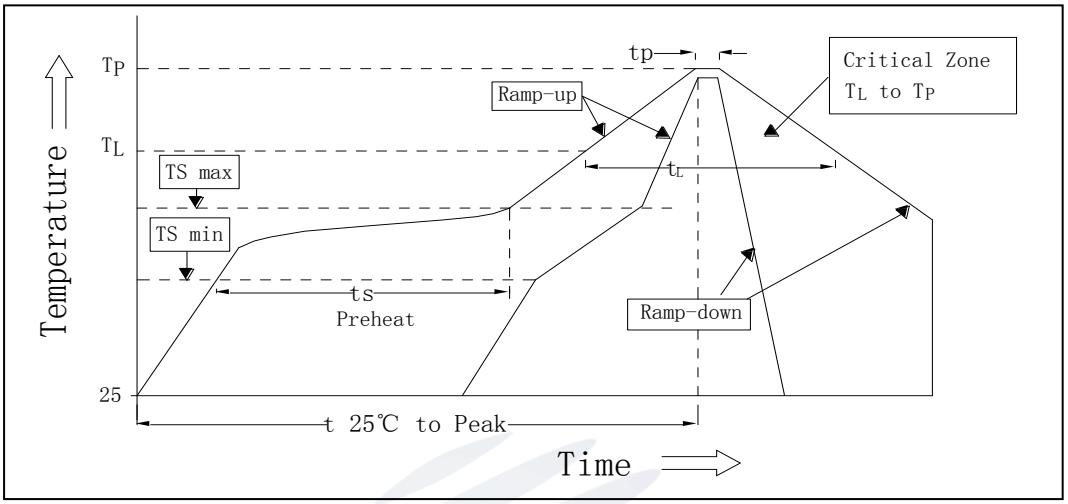


Fig.3-1Title

Table 3-1Title

Average temperature rise speed平均升温速度（Tsmax至T_P）	最高3 °C/秒 Max 3 °C/ s
Preheating: minimum temperature预热：最低温度 (Tsmin)	150 °C
Preheating: Max temperature预热：最高温度 (Tsmax)	200 °C
Preheating: Time预热：时间（Tsmin至Tsmax）	60 - 120秒 60s-120s
Time limited to maintain high temperature: the temperature限时维持高温：温度 (T_L)	217 °C
Time limited to maintain high temperature: The Time 限时维持高温：时间 (t_L)	最多60秒 Max 60s
Peak /Classification of temperature:峰值 / 分类温度 (T_P)	260 °C
Time limit classification of peak temperature time限时峰值分类温度：时间（t_p）	最多10秒 Max 10s
Hold time within 5 °C with the actual peak temperature (TP)与实际峰值温度 (T_P) 相差 5 °C 以内的保持时间	最多30秒 Max 30s
Cooling speed降温速度	最高6 °C/秒 Max 6 °C/ s
Needed time from 25 °C to Tp25 °C 升至峰值温度所需时间	最多8分钟 Max 8 minutes

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Notes 备注：

(1)Reflow soldering should not be done more than two times. In the case of more than 4 hours passed soldering after first, LEDs will be damaged. 回流焊次数不可以超过两次，两次回流焊的时间间隔如果超过4小时，LED可能由于吸湿而损坏。

(2)Whensoldering , do not put stress on the LEDs during heating.当焊接时，不要在材料受热时用力压胶体表面。

3.1.1 Soldering Iron 烙铁焊接

(1) When hand soldering, keep the temperature of iron below less 300℃ less than 3 seconds 当手工焊接时，烙铁的温度必须小于300℃，时间不可超过3秒。

(2) The hand solder should be done only one time.手工焊接只可焊接一次。

3.1.2 Repairing 修补

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable,a double-head soldering iron should be used (as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.

LED回流焊后不应该修复，当必须修复时，必须使用双头烙铁，而且事先应确认此种方式会不会损坏LED本身的特性。

3.1.3 Cautions 注意事项

（1）The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when usethe picking up nozzle, the pressure on the silicone resin should be proper. LED封装胶为硅胶，表面较软，用力按压胶体表面会影响LED可靠性，因此应有预防措施避免在按压器件，当使用吸嘴时，胶体表面的压力应是恰当的。

(2) Components should not be mounted on warped (non coplanar) portion of PCB. After soldering, do not warp the circuit board.LED 灯珠不要焊接在弯曲的 PCB 板上，焊接之后，也不要弯折线路板。

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(3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering. Do not rapidly cool device after soldering.回流焊之后冷却过程中，不要对材料实加外力，也不要有震动，回流焊后，不要采用激剧冷却的方式。

4. Handling Precautions 产品使用注意事项

4.1 Handling Precautions 产品使用注意事项

(1) LED operating environment and sulfur element composition cannot be over 100PPM in the LEDmating usage material. This is provided for informational purposes only and is not a warranty or endorsement.LED 工作环境及与 LED 适配的材料中硫元素及化合物成份不可超过 100PPM.这只是一个建议，不作任何品质担保。

(2) In order to prevent ex-ternal material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM,the single content of Chlorine elementis required to be less than 900PPM,the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement.为了防止外界物质进入 LED 内部以造成 LED 的损伤，所处环境及所用套件等等，单一的溴元素含量要求小于 900PPM，单一氯元素含量要求小于 900PPM，溴元素与氯元素总含量必须小于 1500PPM. 这只是一个建议，不作任何品质担保。

(3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against theuse of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verifycompatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended tobe used. Attaching LEDs, do not use adhesives that outgas organic vapor. 应用套件中的挥发性物质会渗透到 LED 内部，在通电产生光子及热的条件下，会导致 LED 变色，进而造成严重光衰，提前了解套件材料能够避免产生这些问题。瑞丰反对使用任何对 LED 器件的性能或者可靠性有害的物质或材料，不管这些材料是已经证实了的

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还是仅仅怀疑有害。针对特定的用途和使用环境，瑞丰建议对所有的物质和材料进行相容性的测试。在贴装 LED 时候，不要使用能产生有机挥发性气体的粘结剂。

(4) Handle the component along the side surface by using forceps or appropriate tools; do not directlytouch or Handle the silicone lens surface, it may damage the internal circuitry.通过使用适当的工具从材料侧面夹取，不可直接用手或尖锐金属压胶体表面，它可能会损坏内部电路。

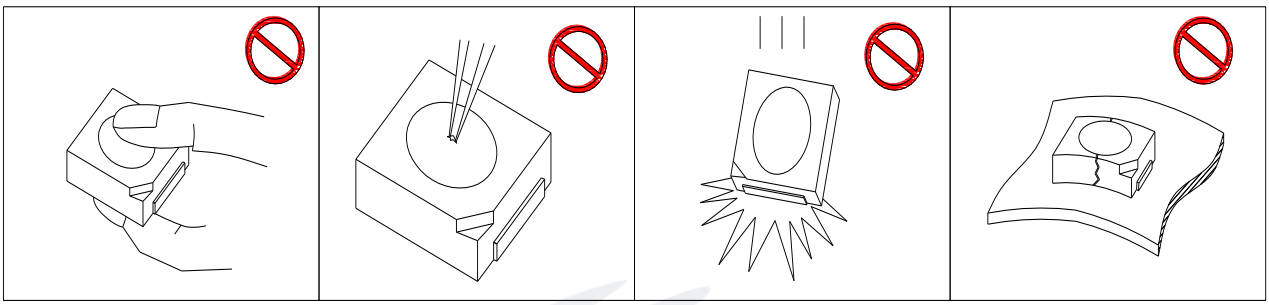


Fig 4-1 Title

(5) In designing a circuit,the current through each LED can not be exceed the absolute maximum rating specified for each LED.In the meanwhile,resistors for protection should be applied,otherwise slight voltage shift will cause big current change,burn out may happen. The driving circuit must be designed to allow forward voltage only when it is ON or OFF.If the reverse voltage is applied to LED, migration can be generated resulting in LED damage. 设计电路时，通过 LED 的电流不能超过规定的最大值，同时，还需使用保护电阻，否则，微小的电压变化将会引起较大电流变化，可能导致产品损毁。电路设计必须保证只有在开启或者关闭的时候出现正向电压的变化，不要施加反压，否则会损坏 LED。

(6) Thermal Design is paramount importance because heat generation may result in the Characteristics decline,such as brightness decreased,Color change and so on.Please consider the heat generation of the LEDs when making the system design.LED 容易因为自身的发热和环境的温度改变而改变，温度升高会降低 LED 发光效率，影响发光颜色，所以在设计时应充分考虑散热问题。

(7) Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust,requiring special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components. Refond suggests using isopropyl alcohol for cleaning. In case

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other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED. 与其他封装胶相比，硅胶通常较软，表面易吸附脏物，应用时应特别注意，当对产品洁净度要求较高时，回流焊以后需要采用恰当的清洗方式，我们推荐用异丙醇作清洗剂，如需要用到其他清洗剂，必须保证不会破坏封装体，超声清洗可能会对 LED 带来损害，不推荐这种清洗方式。

Table 4-1Storage 储存

Conditions 种类		Temperature 温度	Humidity 湿度	Time 时间
Storage 储存	Before Opening Aluminum Bag 拆包前	≤30℃	≤75%	Within 1 Year From Date 一年内
	After Opening Aluminum Bag 拆包后	≤30℃	≤60%	24hours 24小时
Baking 烘烤		60±5℃	≤5%	≥24hours 大于24小时

(8) If the package is flatulence or damaged,please notify the sales staff to assist.如果包装胀气或者破损，请通知销售人员协助处理。

(9)Similar to most Solid state devices; LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). 像其他的半导体电子器件一样，LED 对静电过流击穿非常敏感，需要做好防护。

(10) Other points for attention, please refer to our relevant information.其它注意事项请参照瑞丰相关资料。

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Version History/修订历史

Date日期	Revisor修订者	Version版本	Verifier审核	Remarks备注
2024-05-07	徐恒	E/0	廖志伟	初版发行

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Declare 申明

This specification is written both in English and in Chinese and the latter is formal.

产品规格书以中英文方式书写，若有冲突以中文版本为准。

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